

Datasheet revision 1.1

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Sn42/Bi57.6/Ag0.4 .047" Solid Core Solder Wire 8oz Spool

Product Highlights LOW TEMPERATURE Melts at 138°C (281°F) Lead-Free RoHS 3 and REACH compliant

Specifications Alloy: Wire diameter: Melting Point: Packaging: Shelf Life:

Sn42/Bi57.6/Ag0.4 0.047" (1.2mm) 138°C (281°F) 8oz Spool >60 months



Yes

Storage and Handling Store in a non-corrosive, dry environment.

Please Note: Although Sn42/Bi57.6/Ag0.4 forms strong joints and is more ductile due to the added 0.4% Silver, in wire form it is brittle and needs to be handled gently when unspooling. It is normal for spooled Sn42/Bi57.6/Ag0.4 wire to have some breaks in it.

Test Results

Test J-STD-004 or other requirements as stated	Test Requirement	Result
Conflict Minerals Compliance	Electronic Industry Citizenship Coalition (EICC)	Compliant
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials
conforms to the following Ind	ustry Standards: older Alloys and Fluxed/Non-Fluxed Solders):	Yes

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): RoHS 3 Directive (EU) 2015/863: